

N-channel, 100 V, 1.04 mOhm, MOSFET with enhanced SOA in CCPAK1212 package

29 October 2024

Product data sheet

1. General description

N-channel enhancement mode MOSFET in a CCPAK1212 package qualified to 175 °C. Part of Nexperia's Application Specific MOSFETs (ASFETs) for Hotswap and Soft Start. The PSMN1R0-100ASE delivers very low R_{DSon} and enhanced safe operating area performance in a high-reliability copper-clip package (CCPAK1212).

PSMN1R0-100ASE complements the latest "hot-swap" controllers - robust enough to withstand substantial inrush currents during turn-on, low R_{DSon} to minimize I²R losses and deliver optimum efficiency when turned fully ON.

2. Features and benefits

- Fully optimized Safe Operating Area (SOA) for superior linear mode operation
- Low R_{DSon} for low I²R conduction losses
- CCPAK1212 package for applications that demand the highest performance and reliability

3. Applications

- Hot swap
 - Load switch
- Soft start
- E-fuse
- Telecommunication systems based on a 48 V backplane/supply rail

4. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C	-	-	100	V
ID	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	-	-	430	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>	-	-	1.55	kW
Static chara	acteristics					
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 11	-	0.82	1.04	mΩ
Dynamic cl	haracteristics					
Q _{GD}	gate-drain charge	$\label{eq:ID} \begin{array}{l} I_D = 25 \text{ A}; \ V_{DS} = 50 \text{ V}; \ V_{GS} = 10 \text{ V}; \\ T_j = 25 \ ^\circ\text{C}; \ \overline{\text{Fig. 13}}; \ \overline{\text{Fig. 14}} \end{array}$	14.5	48.2	111	nC
Source-dra	in diode	· · ·				
Q _r	recovered charge	I _S = 25 A; dI _S /dt = -100 A/μs; V _{GS} = 0 V; V _{DS} = 50 V; T _i = 25 °C; <u>Fig. 17</u>	-	110	-	nC

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5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	S	source		
3	S	source		
4	S	source	12 11 10 9 8 7	
5	S	source	BBBBBB	
6	S	source		D
7	D	drain		
8	D	drain		G
9	D	drain	<u>'eeeeee</u> '	mbb076 S
10	D	drain	1 2 3 4 5 6 CCPAK1212 (SOT8000A)	
11	D	drain	GUTAR 1212 (SU10000A)	
12	D	drain		
mb	D	mounting base; connected to drain		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PSMN1R0-100ASE		Plastic, surface mounted copper clip package (CCPAK1212); 13 terminals; 2.0 mm pitch, 12 mm x 12 mm x 2.5 mm body	SOT8000A

7. Marking

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Table 4. Marking codes	
Type number	Marking code
PSMN1R0-100ASE	XP1E0S10A

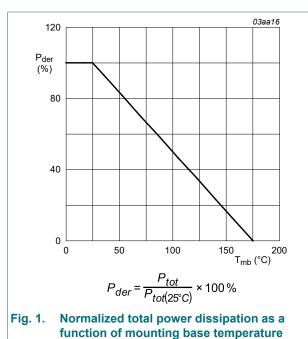
8. Limiting values

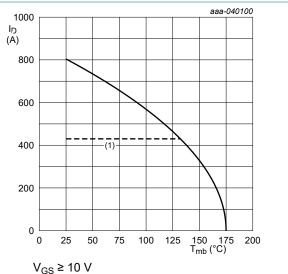
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	100	V
V _{DGR}	drain-gate voltage	25 °C ≤ T _j ≤ 175 °C; R _{GS} = 20 kΩ		-	100	V
V _{GS}	gate-source voltage			-20	20	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	1.55	kW
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>		-	430	А
		V _{GS} = 10 V; T _{mb} = 100 °C; <u>Fig. 2</u>		-	430	А
I _{DM}	peak drain current	pulsed; t _p ≤ 10 µs; T _{mb} = 25 °C; <u>Fig. 3</u>		-	3216	А
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
T _{sld(M)}	peak soldering temperature			-	260	°C
Source-drai	n diode					
I _S	source current	T _{mb} = 25 °C		-	430	А
I _{SM}	peak source current	pulsed; t _p ≤ 10 µs; T _{mb} = 25 °C		-	3216	А
Avalanche r	ruggedness				-	_
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$ \begin{array}{l} I_{D} = 117 \; A; \; V_{sup} \leq \; 100 \; V; \; R_{GS} = 50 \; \Omega; \\ V_{GS} = 10 \; V; \; T_{j(init)} = 25 \; ^{\circ}C; \; unclamped; \\ t_{p} = 214 \; \mu s; \; \underline{Fig. \; 4} \end{array} $	[1]	-	1630	mJ
I _{AS}	non-repetitive avalanche current	$V_{sup} \le 100 \text{ V}; V_{GS} = 10 \text{ V}; T_{j(init)} = 25 \text{ °C}; R_{GS} = 50 \Omega; Fig. 4$	[1]	-	117	A

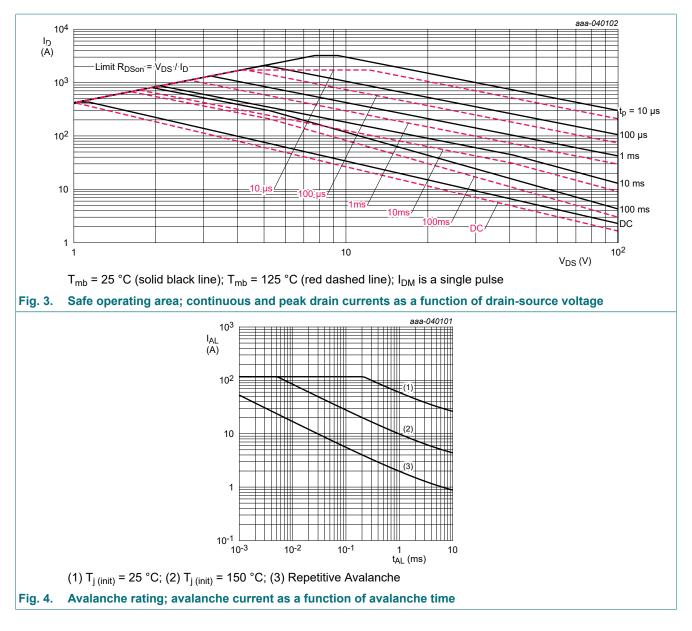
[1] Protected by 100% test





(1) 430 A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

Fig. 2. Continuous drain current as a function of mounting base temperature

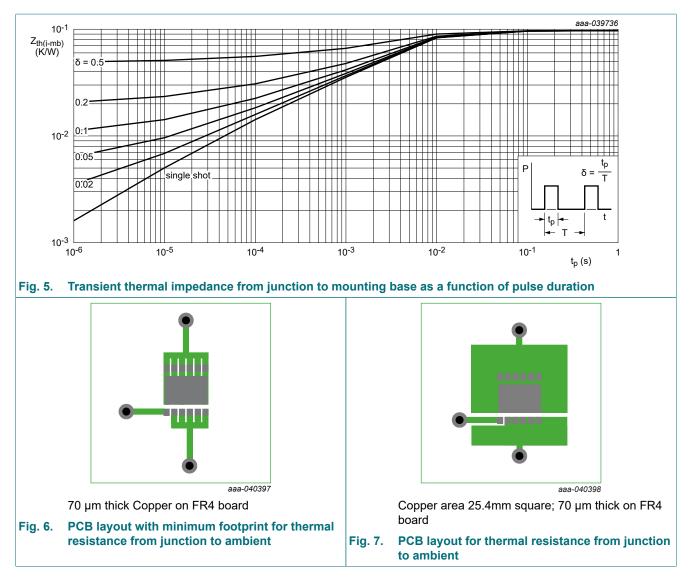


9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. <u>5</u>	-	0.075	0.1	K/W
R _{th(j-a)}	thermal resistance from	Fig. 6	-	58	-	K/W
	junction to ambient	Fig. 7	-	29	-	K/W

N-channel, 100 V, 1.04 mOhm, MOSFET with enhanced SOA in CCPAK1212 package

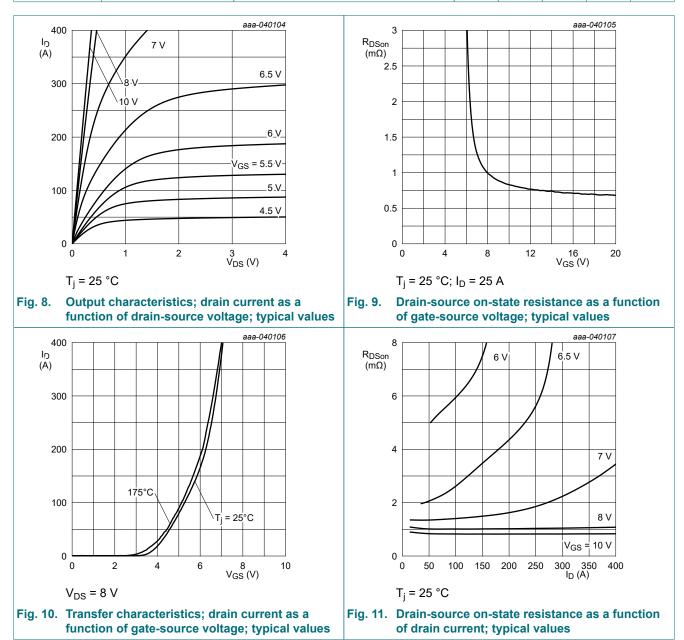


10. Characteristics

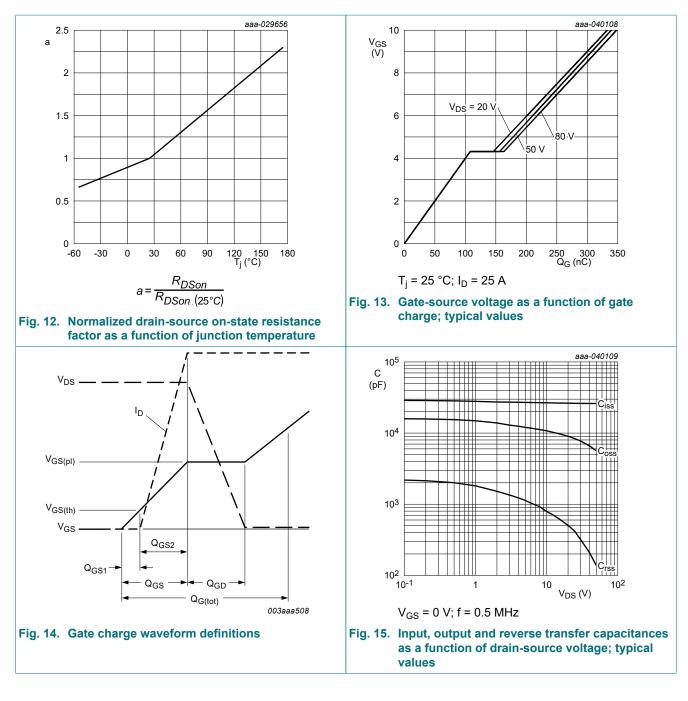
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static charac	cteristics					
V _{(BR)DSS}	drain-source	I _D = 250 μA; V _{GS} = 0 V; T _i = 25 °C	100	-	-	V
()	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _i = -55 °C	90	-	-	V
V _{GS(th)}	gate-source threshold	I _D = 1 mA; V _{DS} =V _{GS} ; T _i = 25 °C	2	2.6	3.6	V
	voltage	I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C	-	1.55	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C}$	-	3	-	V
ΔV _{GS(th)} /ΔT	gate-source threshold voltage variation with temperature	25 °C ≤ T _j ≤ 150 °C	-	-6.6	-	mV/ł
I _{DSS}	drain leakage current	V _{DS} = 100 V; V _{GS} = 0 V; T _j = 25 °C	-	0.06	2	μA
		V _{DS} = 100 V; V _{GS} = 0 V; T _j = 125 °C	-	40	200	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 11	-	0.82	1.04	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 100 °C; Fig. 12	-	1.2	1.7	mΩ
		V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; Fig. 12	-	1.7	2.4	mΩ
R _G	gate resistance	f = 1 MHz; T _j = 25 °C	0.64	1.27	2.55	Ω
Dynamic cha	aracteristics	· ·				
Q _{G(tot)}	total gate charge	$\label{eq:ID} \begin{array}{ c c c c c c c c c c c c c c c c c c c$	170	339	509	nC
		$ I_D = 0 \text{ A}; \text{V}_{DS} = 0 \text{ V}; \text{V}_{GS} = 10 \text{ V}; \\ \text{T}_j = 25 ^\circ\text{C} $	-	312	-	nC
Q _{GS}	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$	64.8	108	151	nC
Q _{GS(th)}	pre-threshold gate- source charge	T _j = 25 °C; <u>Fig. 13; Fig. 14</u>	-	73.6	-	nC
Q _{GS(th-pl)}	post-threshold gate- source charge		-	34.4	-	nC
Q _{GD}	gate-drain charge	1	14.5	48.2	111	nC
V _{GS(pl)}	gate-source plateau voltage	$I_D = 25 \text{ A}; V_{DS} = 50 \text{ V}; T_j = 25 \text{ °C};$ Fig. 13; Fig. 14	-	4.3	-	V
C _{iss}	input capacitance	V _{DS} = 50 V; V _{GS} = 0 V; f = 0.5 MHz;	15626	26043	36460	pF
C _{oss}	output capacitance	T _j = 25 °C; <u>Fig. 15</u>	3381	5635	9015	pF
C _{rss}	reverse transfer capacitance		14	137	356	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 50 \text{ V}; \text{ R}_{L} = 2 \Omega; \text{ V}_{GS} = 10 \text{ V};$	-	87	-	ns
t _r	rise time	$R_{G(ext)} = 5 \Omega; T_j = 25 °C$	-	91	-	ns
t _{d(off)}	turn-off delay time] [-	212	-	ns
t _f	fall time		-	131	-	ns
Source-drain	diodo					

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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
t _{rr}		$I_{S} = 25 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$	-	74	-	ns
Qr	recovered charge	V _{DS} = 50 V; T _j = 25 °C; <u>Fig. 17</u>	-	110	-	nC



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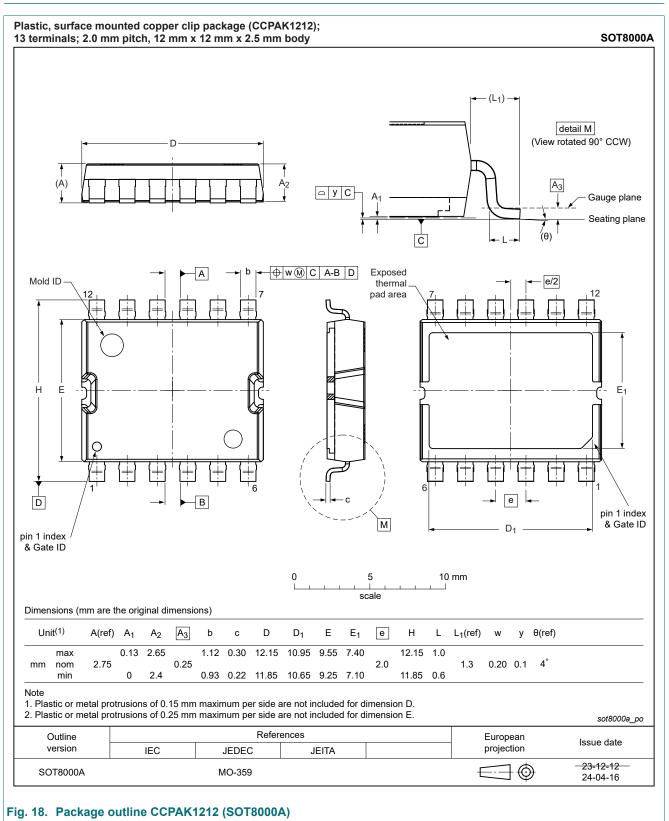
Product data sheet

aaa-040110 003aal160 400 I_S (A) I_D (A) 300 t_{rr} tb 0 200 0.25 I_{RM} 100 175°C $T_j = 25^{\circ}C$ IRM 0 t (s) 0.2 0.4 0.6 0.8 0 1 V_{SD} (V) 1.2 Fig. 17. Reverse recovery timing definition V_{GS} = 0 V Fig. 16. Source-drain (diode forward) current as a function of source-drain (diode forward) voltage; typical values

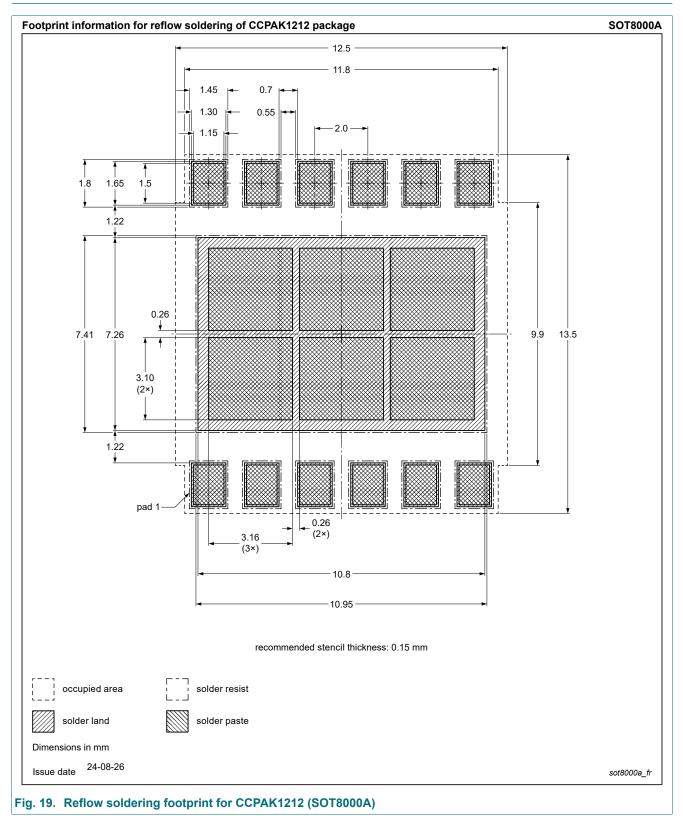
N-channel, 100 V, 1.04 mOhm, MOSFET with enhanced SOA in CCPAK1212 package

PSMN1R0-100ASE

11. Package outline



12. Soldering



13. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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 Please consult the most recently issued document before initiating or completing a design.

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Contents

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Marking	2
8.	Limiting values	3
9.	Thermal characteristics	4
10.	. Characteristics	6
11.	. Package outline	10
12	. Soldering	11
13.	. Legal information	12

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PSMN1R0-100ASE